

Graphene Device and Process Integration – Opportunities and Challenges

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Graphene Device and Process Integration - Challenges ahead!

Graphene research has matured from fundamental investigations of material properties to very specific demonstrations of devices and their potential for applications. In this talk, I will present several promising areas, where the exceptional properties of graphene may be exploited. Two examples are graphene-based hot electron transistors [1], [2] and graphene-membrane-based nanoelectromechanical systems [3], [4]. However, proper device and process integration remains challenging and currently prevents commercialization. Several open issues such as contamination, graphene transfer and electrical contacts will be discussed in detail [5], [6] [7].

References

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- [4] S. Wagner *et al.*, *Nano Lett.*, 17 (2015)
- [5] G. Lupina *et al.*, *ACS Nano*, 9 (2015) 4776–4785
- [6] S. Wagner *et al.*, *Microelectron. Eng.*, 159 (2016) 108–113
- [7] A. Gahoi *et al.*, *Solid State Electronics*, 125 (2016), 234-239

Figures

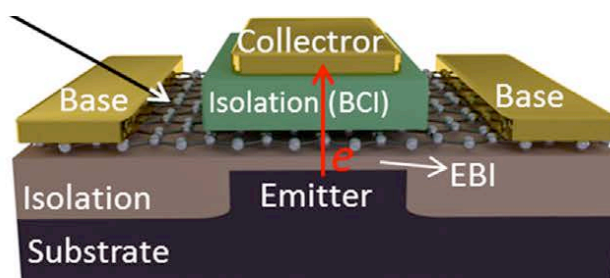


Figure 1: Schematic of a graphene-based hot electron transistor. The red arrow indicates the direction of electron transport, perpendicular to the graphene layer(s).

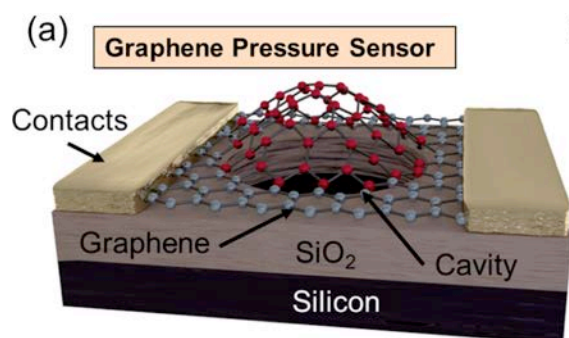


Figure 2: Schematic of a graphene-membrane-based pressure sensor.

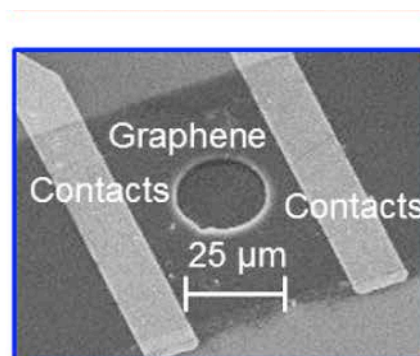


Figure 3: Scanning electron micrograph of a graphene-membrane-based pressure sensor.